

Features

- CMTI: 100 kV/μs
- Input Voltage Range: ±250 mV
- Very Low Offset Error: Maximum 150 μV at 25°C
- Very Low Gain Error: 0.15% Maximum at 25°C
- System-level Diagnostic Features
- Wide Temperature Range: -40°C to +125°C
- Finished Safety-Related Certifications:
 - CQC Certification per GB 4943.1
 - CB Certifications
 - 5000-V_{RMS} Isolation Rating per UL 1577
- Ongoing Safety-Related Certifications:
 - VDE Certification according to DIN VDE V 0884-17(IEC60747-17)
 - CSA, TUV Certifications

Description

The device is a precision, delta-sigma modulator with an output separated from the input circuitry by capacitive silicon dioxide insulation barrier. This barrier of WSOP8 package is certified to provide isolation of up to 5000-V_{RMS} according to UL1577.

The common-mode transient immunity (CMTI) of the device has been significantly enhanced through innovative circuit design and optimized structure.

The input of the devices is designed to connect to shunt resistors or other low-voltage level signal sources. The excellent performance of the device supports accurate current control in motor control applications. The common-mode overvoltage and missing high-side supply voltage detection features system-level diagnostics.

The devices are available in WSOP8 and TSSOP8 packages, and are characterized from -40°C to +125°C.

Applications

- Industrial Automation
- Motor Control
- Power Supplies

Typical Application Circuit

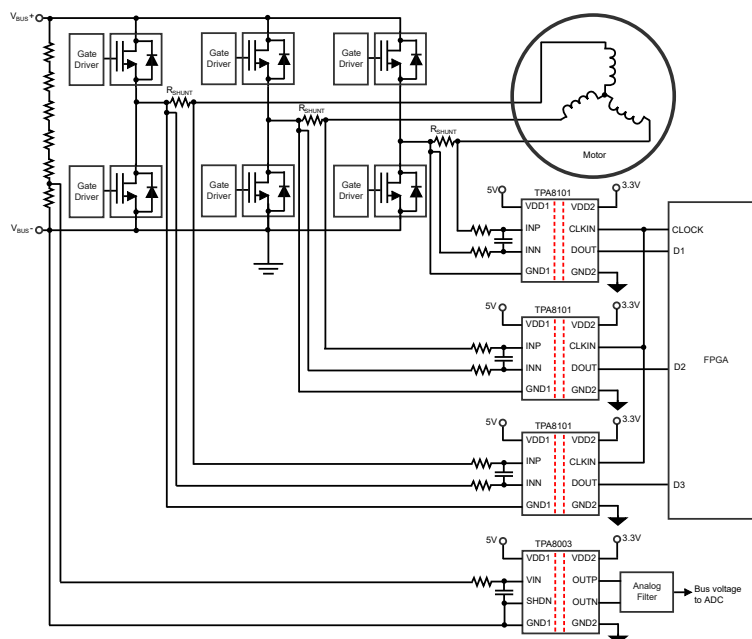


Table of Contents

Features	1
Applications	1
Description	1
Typical Application Circuit	1
Revision History	3
Pin Configuration and Functions	4
Specifications	5
Absolute Maximum Ratings ⁽¹⁾	5
ESD, Electrostatic Discharge Protection.....	5
Recommended Operating Conditions.....	5
Thermal Information.....	5
Insulation Specifications.....	6
Safety-Related Certifications.....	8
Safety Limiting Values.....	9
Electrical Characteristics.....	10
Typical Performance Characteristics.....	13
Detailed Description	16
Overview.....	16
Functional Block Diagram.....	16
Feature Description.....	16
Application and Implementation	17
Typical Application.....	17
Tape and Reel Information	18
Package Outline Dimensions	19
WSOP8-B.....	19
TSSOP8.....	20
Order Information	21
IMPORTANT NOTICE AND DISCLAIMER	22

Revision History

Date	Revision	Notes
2023-09-29	Rev.A.0	Initial version.

Pin Configuration and Functions

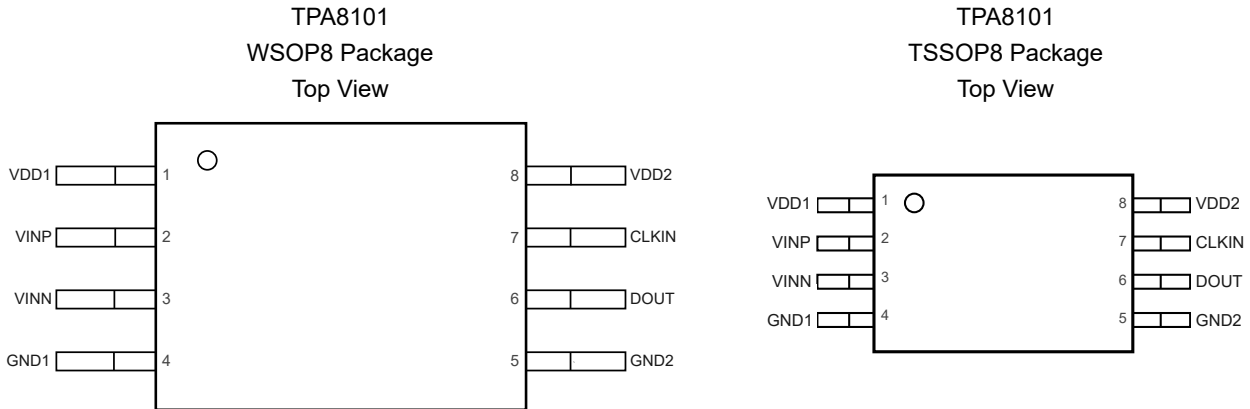


Table 1. Pin Functions

Pin		I/O	Description
No.	Name		
1	VDD1		High-side power supply
2	VINP	Input	Positive analog input
3	VINN	Input	Negative analog input
4	GND1		High-side analog ground
5	GND2		Low-side analog ground
6	DOUT	Output	Modulator data output
7	CLKIN	Input	Modulator clock input
8	VDD2		Low-side power supply

Specifications

Absolute Maximum Ratings ⁽¹⁾

Parameter		Min	Max	Unit
VDD	Supply Voltage, VDD1 to GND1 or VDD2 to GND2	-0.3	7	V
V _{INPUT}	Analog Input Voltage at VINP, VINN	GND1 – 6	VDD1 + 0.5	V
	Digital Input or Output Voltage at CLKIN, DOUT	GND1 – 0.5	VDD2 + 0.5	V
I _{IN}	Input Current to Any Pin except Supply Pins	-10	10	mA
T _J	Operating Virtual Junction Temperature		150	°C
T _{stg}	Storage Temperature	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

ESD, Electrostatic Discharge Protection

Symbol	Parameter	Condition	Value	Unit
HBM	Human Body Model ESD	ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	2	kV
CDM	Charged Device Model ESD	ANSI/ESDA/JEDEC JS-002 ⁽²⁾	1.5	kV

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

Recommended Operating Conditions

Parameter		Min	Typ	Max	Unit
VDD1	High-side Supply Voltage (VDD1 to GND1)	3.0	5.0	5.5	V
VDD2	Low-side Supply Voltage (VDD2 to GND2)	3.0	3.3	5.5	V
T _A	Operating Ambient Temperature	-40	25	125	°C

Thermal Information

Package Type	θ_{JA}	θ_{JC}	Unit
WSOP8	85	43	°C/W
TSSOP8	191	44	°C/W

Insulation Specifications

The value of UL and VDE is provided by lab test, the UL and VDE certifications is ongoing.

Parameter		Conditions	Value		Unit
			WSOP8	TSSOP8	
CLR	External clearance	Shortest terminal-to-terminal distance through air	8.0		mm
CPG	External creepage	Shortest terminal-to-terminal distance across the package surface	8.0		mm
DTI	Distance through the insulation	Minimum internal gap (internal clearance)	22		μm
DTC	Distance through the Molding compound	Minimum internal distance across the conductors inside the package	0.8		mm
CTI	Comparative tracking index	DIN EN 60112 (VDE 0303-11); IEC 60112; UL 746A	> 600		V
	Material group	According to IEC 60664-1	I		
	Over-voltage category	For Rated Mains Voltage ≤ 150 V _{RMS}	I-IV		
		For Rated Mains Voltage ≤ 300 V _{RMS}	I-IV		
		For Rated Mains Voltage ≤ 600 V _{RMS}	I-IV		
		For Rated Mains Voltage ≤ 1000 V _{RMS}	I-III		
	Climatic category		40/125/21		
	Pollution degree		2		
DIN V VDE V 0884-17 (1)(2)					
V _{IORM}	Maximum repetitive isolation voltage	AC voltage	1700		V _{PK}
V _{IOWM}	Maximum working isolation voltage	AC voltage; TDDB Test	1200		V _{RMS}
		DC voltage	1700		V _{DC}
V _{IOTM}	Maximum transient isolation voltage	V _{TEST} = V _{IOTM} , t = 60 s (qualification); V _{TEST} = 1.2 × V _{IOTM} , t = 1 s (100% production)	7000		V _{PK}
V _{IOSM}	Maximum surge isolation voltage ⁽³⁾	Test method per IEC 62368-1, 1.2/50 μs waveform, V _{TEST} = 1.3 × V _{IOSM} (qualification)	6500		V _{PK}
q _{pd}	Apparent charge	Method a, After Input/Output safety test subgroup 2/3, V _{ini} = V _{IOTM} , t _{ini} = 60 s; V _{pd(m)} = 1.2 × V _{IORM} , t _m = 10 s	≤ 5		pC
		Method a, After environmental tests subgroup 1, V _{ini} = V _{IOTM} , t _{ini} = 60 s; V _{pd(m)} = 1.6 × V _{IORM} , t _m = 10 s	≤ 5		
		Method b1; At routine test (100% production) and preconditioning (type	≤ 5		

Isolated Delta-Sigma Modulators

Parameter		Conditions	Value		Unit
			WSOP8	TSSOP8	
		test), $V_{ini} = 1.2 \times V_{IOTM}$, $t_{ini} = 1 \text{ s}$; $V_{pd(m)}$ $= 1.875 \times V_{IORM}$, $t_m = 1 \text{ s}$			
C_{IO}	Isolation capacitance	$V_{IO} = 0.4 \times \sin(2\pi f t)$, $f = 1 \text{ MHz}$	~0.5		pF
R_{IO}	Isolation resistance	$V_{IO} = 500 \text{ V}$, $T_A = 25^\circ\text{C}$	$> 10^{12}$		Ω
		$V_{IO} = 500 \text{ V}$, $100^\circ\text{C} \leq T_A \leq 125^\circ\text{C}$	$> 10^{11}$		Ω
		$V_{IO} = 500 \text{ V}$ at $T_S = 150^\circ\text{C}$	$> 10^9$		Ω
UL 1577					
V_{ISO}	Withstanding isolation voltage	$V_{TEST} = V_{ISO}$, $t = 60 \text{ s}$ (qualification); $V_{TEST} = 1.2 \times V_{ISO}$, $t = 1 \text{ s}$ (100% production)	5000		V_{RMS}

- (1) All pins on each side of the barrier are tied together creating a two-terminal device.
- (2) This coupler is suitable for safe electrical insulation only within the safety operating ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.
- (3) Testing must be carried out in oil.

Safety-Related Certifications

VDE	UL	TUV	CQC	CSA	CB
Certified according to DIN VDE V 0884-17	Certified according to UL 1577 and CSA Component Acceptance Notice 5A	Certified according to EN IEC 62368-1 and EN IEC 61010-1	Certified according to GB 4943.1	Certified CSA C22.2 No. 62368-1 and CAN/CSA-C22.2 No. 60601-1	Certified according to EN IEC 62368-1
	(WSOP)Single protection, 5000Vrms		Reinforced insulation (WSOP)		Reinforced insulation (WSOP)
Certificate No.	Report Reference E524241	Registration No.	Certificate No. CQC23001393276	Master contract:	Ref. Certif. No. CN59992

Safety Limiting Values

Parameter	Conditions ⁽¹⁾	Min	Typ	Max	Unit
Safety input, output or supply current	$R_{\theta JA} = 85^{\circ}\text{C/W}$, $VDD1 = VDD2 = 5.5\text{ V}$, $T_J = 150^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, WSOP8 Package			267	mA
	$R_{\theta JA} = 191^{\circ}\text{C/W}$, $VDD1 = VDD2 = 5.5\text{ V}$, $T_J = 150^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, TSSOP8 Package			119	mA
	$R_{\theta JA} = 85^{\circ}\text{C/W}$, $VDD1 = VDD2 = 3.6\text{ V}$, $T_J = 150^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, WSOP8 Package			408	mA
	$R_{\theta JA} = 191^{\circ}\text{C/W}$, $VDD1 = VDD2 = 3.6\text{ V}$, $T_J = 150^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, TSSOP8 Package			182	mA
Safety total power	$R_{\theta JA} = 85^{\circ}\text{C/W}$, $T_J = 150^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, WSOP8 Package			1470	mW
	$R_{\theta JA} = 191^{\circ}\text{C/W}$, $T_J = 150^{\circ}\text{C}$, $T_A = 25^{\circ}\text{C}$, TSSOP8 Package			655	mW
Maximum safety temperature				150	$^{\circ}\text{C}$

(1) The assumed junction-to-air thermal resistance in the Thermal Information is that of a device installed on a high-K test board for leaded surface-mount packages.

Electrical Characteristics

Minimum and maximum specifications apply from $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, $V_{DD1} = 3.0\text{ V}$ to 5.5 V , $V_{DD2} = 3.0\text{ V}$ to 5.5 V , $V_{INP} = -250\text{ mV}$ to $+250\text{ mV}$, and $V_{INN} = 0\text{ V}$; typical specifications are at $T_A = 25^\circ\text{C}$, $V_{DD1} = 5\text{ V}$, and $V_{DD2} = 3.3\text{ V}$, unless otherwise noted.

Parameter	Conditions	Min	Typ	Max	Unit	
Analog Input						
$V_{Clipping}$	Differential input voltage before clipping output	$V_{INP} - V_{INN}$		± 320	mV	
V_{FSR}	Specified linear differential full-scale	$V_{INP} - V_{INN}$	-250	250	mV	
V_{CM}	Specified common-mode input voltage	$(V_{INP} + V_{INN}) / 2$ to GND1	-0.16	$V_{DD1} - 2.5$	V	
	Absolute common-mode input voltage ⁽¹⁾	$(V_{INN} + V_{INP}) / 2$ to GND1	-2	V_{DD1}	V	
V_{CMov}	Common-mode overvoltage detection level		$V_{DD1} - 2.4$		V	
CMRR	Common-mode rejection ratio	$f_{IN} = 0\text{ Hz}$, $V_{CM\ min} \leq V_{CM} \leq V_{CM\ max}$		-95	dB	
		$f_{IN} = 10\text{ kHz}$, $V_{CM\ min} \leq V_{CM} \leq V_{CM\ max}$		-100		
C_{IND}	Differential input capacitance		1		pF	
R_{IN}	Single-ended input resistance	$V_{INN} = \text{GND1}$		19	k Ω	
R_{IND}	Differential input resistance			22	k Ω	
I_{IB}	Input bias current	$V_{INP} = V_{INN} = \text{GND1}$, $I_{IB} = (I_{IBP} + I_{IBN}) / 2$	-22	-17	μA	
TC_{IB}	Input bias current drift			1	nA/ $^\circ\text{C}$	
BW_{IN}	Input bandwidth			1.2	MHz	
DC Accuracy						
DNL	Differential nonlinearity ⁽¹⁾	Resolution: 16 bits	-0.99		0.99	LSB
INL	Integral nonlinearity ⁽¹⁾	Resolution: 16 bits	-4	± 1	4	LSB
E_O	Offset error	$V_{DD1} = 5\text{ V}$, $T_A = 25^\circ\text{C}$, $V_{INP} = V_{INN} = \text{GND1}$	-150	± 5	150	μV
TCE_O	Offset error thermal drift ⁽¹⁾		-1	± 0.15	1	$\mu\text{V}/^\circ\text{C}$
E_G	Gain error	at 25°C	-0.15	± 0.005	0.15	%
TCE_G	Gain error thermal drift ⁽¹⁾		-40	± 20	40	ppm/ $^\circ\text{C}$
PSRR	Power-supply rejection ratio	$V_{INP} = V_{INN} = \text{GND1}$, $3.0\text{ V} \leq V_{DD1} \leq 5.5\text{ V}$, at dc		90		dB
		$V_{INP} = V_{INN} = \text{GND1}$, $V_{DD1} = 5\text{ V}$, 10 kHz, 100-mV ripple		80		dB
AC Accuracy						

Isolated Delta-Sigma Modulators

Parameter		Conditions	Min	Typ	Max	Unit
SNR	Signal-to-noise ratio	$f_{IN} = 1 \text{ kHz}$		86		dB
SINAD	Signal-to-noise + distortion	$f_{IN} = 1 \text{ kHz}$		85		dB
THD	Total harmonic distortion	VDD1 = 5.0 V, 5 MHz \leq $f_{CLKIN} \leq$ 20 MHz, $f_{IN} = 1$ kHz		-82		dB
		VDD1 = 3.3 V, 5 MHz \leq $f_{CLKIN} \leq$ 20 MHz, $f_{IN} = 1$ kHz		-80		dB
SFDR	Spurious-free dynamic range	$f_{IN} = 1 \text{ kHz}$		84		dB
Digital Inputs/Outputs						
I_{IN}	Input current ⁽¹⁾	$GND2 \leq V_{IN} \leq VDD2$			7	μA
C_{IN}	Input capacitance			4		pF
V_{IH}	High-level input voltage ⁽¹⁾		$0.7 \times VDD2$			V
V_{IL}	Low-level input voltage ⁽¹⁾				$0.3 \times VDD2$	V
CLOAD	Output load capacitance	$f_{CLKIN} = 20 \text{ MHz}$		30		pF
VOH	High-level output voltage	$I_{OH} = -20 \mu\text{A}$	$VDD2 - 0.1$			V
		$I_{OH} = -4 \text{ mA}$	$VDD2 - 0.4$			
VOL	Low-level output voltage	$I_{OL} = 20 \mu\text{A}$			0.1	V
		$I_{OL} = 4 \text{ mA}$			0.4	V
Power Supply						
VDD1 _{UV}	undervoltage detection threshold voltage of VDD1	VDD1 falling		2.1	2.4	V
I _{DD1}	High-side supply current	$3.0 \text{ V} \leq VDD1 \leq 5.5 \text{ V}$		13	18	mA
I _{DD2}	Low-side supply current	$3.0 \text{ V} \leq VDD2 \leq 5.5 \text{ V}$		4	8	mA
Switching Characteristics ⁽¹⁾						
f_{CLKIN}	CLKIN clock frequency	$4.5 \text{ V} \leq VDD2 \leq 5.5 \text{ V}$	5		21	MHz
		$3.0 \text{ V} \leq VDD2 \leq 5.5 \text{ V}$	5		20	
t_{CLKIN}	CLKIN clock period	$4.5 \text{ V} \leq VDD2 \leq 5.5 \text{ V}$	47.6		200	ns
		$3.0 \text{ V} \leq VDD2 \leq 5.5 \text{ V}$	50		200	
t_{HIGH}	CLKIN clock high time		20	25	120	ns
t_{LOW}	CLKIN clock low time		20	25	120	ns
t_H	DOUT hold time after rising edge of CLKIN	$C_{LOAD} = 15 \text{ pF}$	3.1			ns
t_D	Rising edge of CLKIN to DOUT valid delay	$C_{LOAD} = 15 \text{ pF}$			15	ns

Parameter		Conditions	Min	Typ	Max	Unit
t _r	DOUT rise time	10% to 90%, 2.7 V ≤ VDD2 ≤ 3.6 V, C _{LOAD} = 15 pF		0.8	3	ns
		10% to 90%, 4.5 V ≤ VDD2 ≤ 5.5 V, C _{LOAD} = 15 pF		0.8	3	
t _f	DOUT fall time	90% to 10%, 2.7 V ≤ VDD2 ≤ 3.6 V, C _{LOAD} = 15 pF		0.8	3	ns
		90% to 10%, 4.5 V ≤ VDD2 ≤ 5.5 V, C _{LOAD} = 15 pF		0.8	3	
t _{ISTART}	Interface startup time	VDD2 at 3 V (min) to DOUT valid with VDD1 ≥ 3 V		32		CLKIN cycles
t _{ASTART}	Analog startup time	VDD1 step to 3.0 V with VDD2 ≥ 3 V, 0.1% settling		0.5		ms

(1) Provided by bench test or design simulation.

Typical Performance Characteristics

All test conditions: VDD1 = 5 V, VDD2 = 3.3 V, VINP = -250 mV to 250 mV, VINN = 0 V, unless otherwise noted.

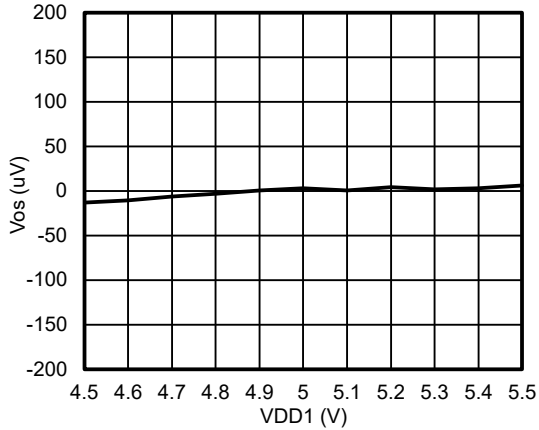


Figure 1. VOS vs VDD1

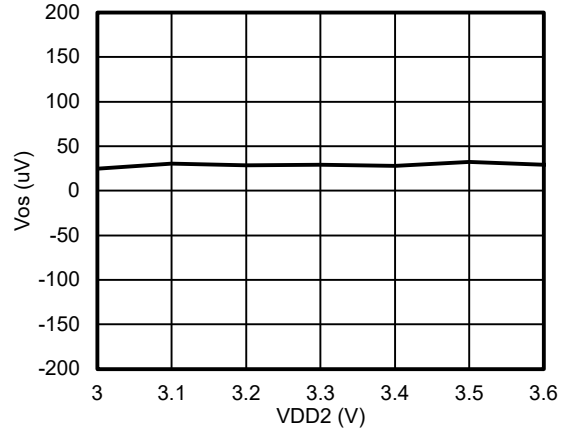


Figure 2. VOS vs VDD2

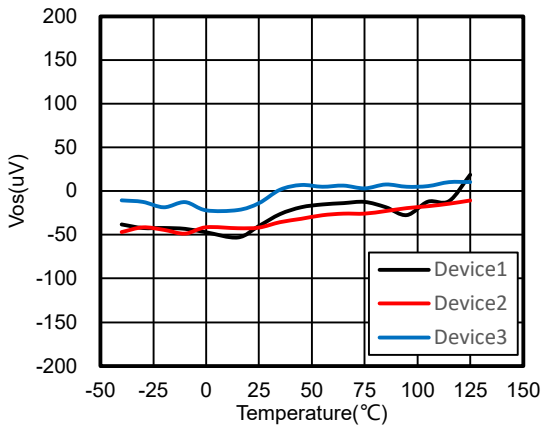


Figure 3. VOS vs Temperature

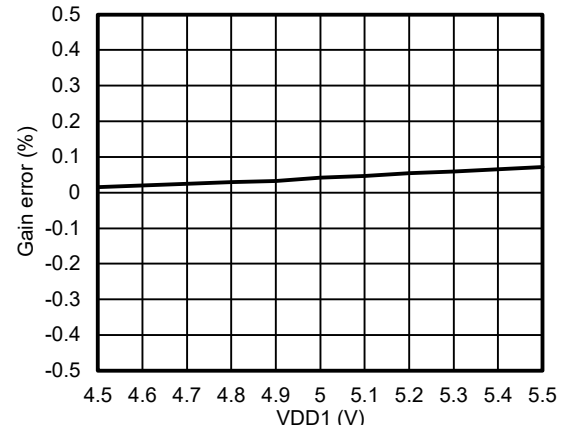


Figure 4. Gain Error vs VDD1

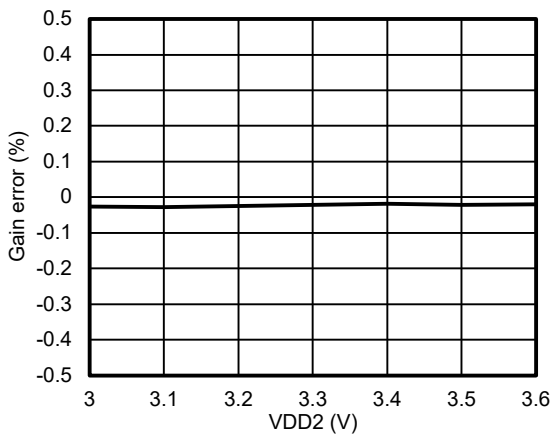


Figure 5. Gain Error vs VDD2

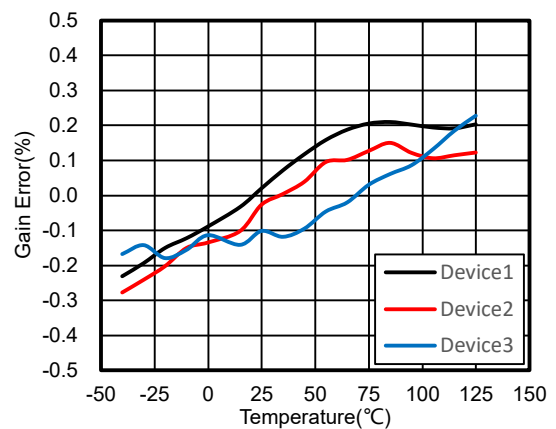


Figure 6. Gain Error vs Temperature

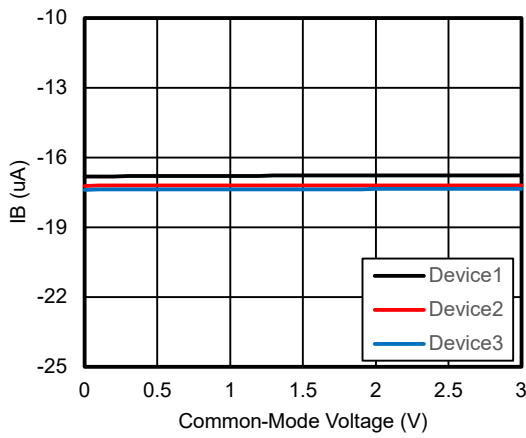


Figure 7. IB vs Common-Mode Voltage

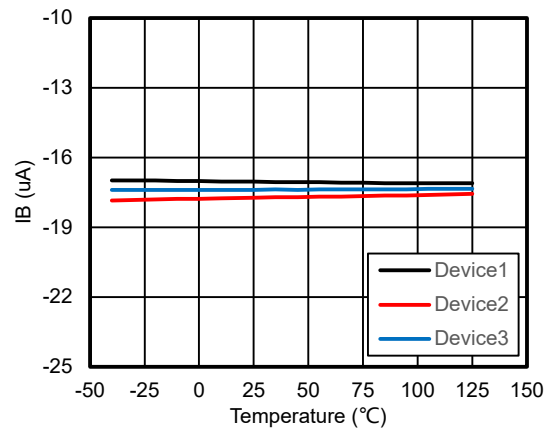


Figure 8. IB vs Temperature

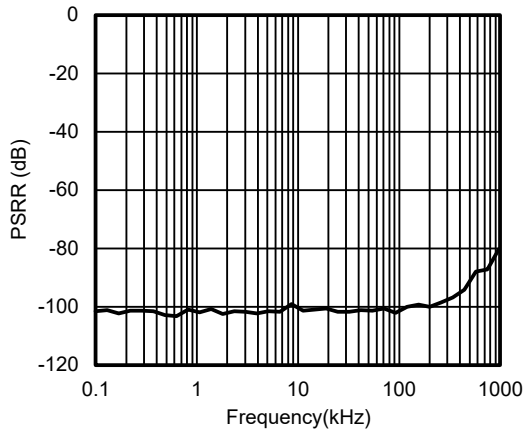


Figure 9. VDD1 PSRR vs Frequency

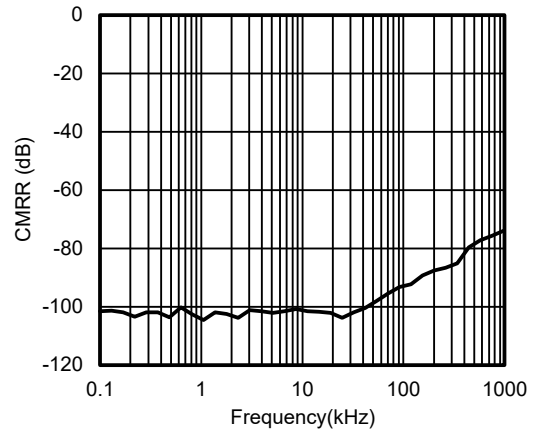


Figure 10. CMRR vs Frequency

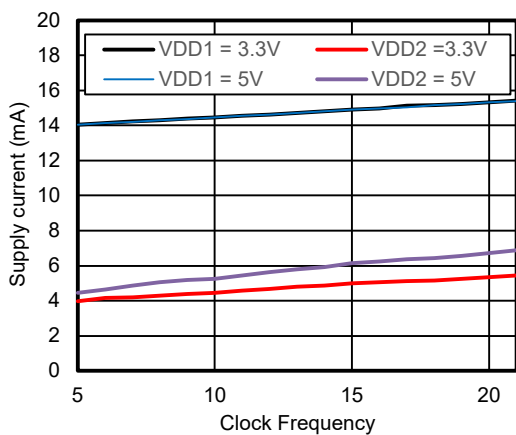


Figure 11. Supply Current vs Clock Frequency

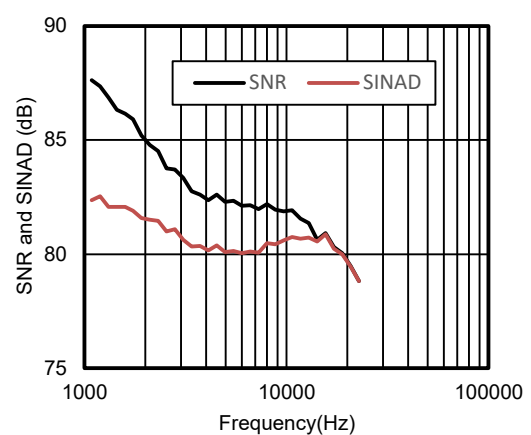
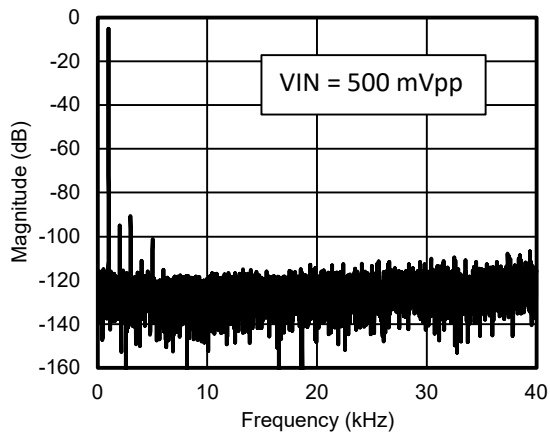
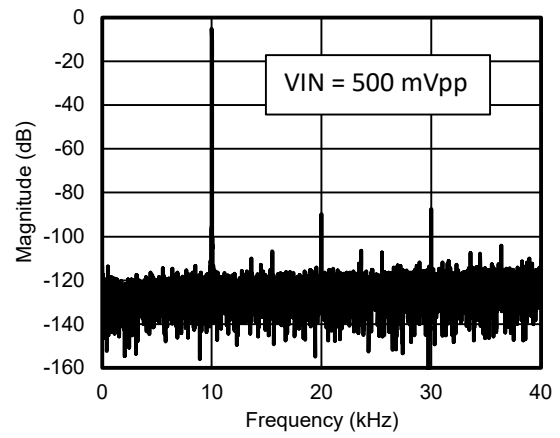


Figure 12. SNR and SINAD vs Input Signal Frequency

Isolated Delta-Sigma Modulators**Figure 13. Frequency Spectrum with 1-kHz Input Signal****Figure 14. Frequency Spectrum with 10-kHz Input Signal**

Detailed Description

Overview

The differential analog input of the device is a fully-differential amplifier feeding the switched-capacitor input of a delta-sigma ($\Delta\Sigma$) modulator stage which digitizes the input signal into a 1-bit output stream. The isolated data output DOUT of the converter provides a stream of digital zeros and ones that is synchronous to the clock source at the CLKIN pin with a frequency in the range of 5 MHz to 21 MHz. The time average of this serial bitstream output is proportional to the analog input voltage.

Based on SiO₂-based, double-capacitive isolation barrier, the digital modulation and isolation barrier characteristics provide the device high reliability and common-mode transient immunity.

Functional Block Diagram

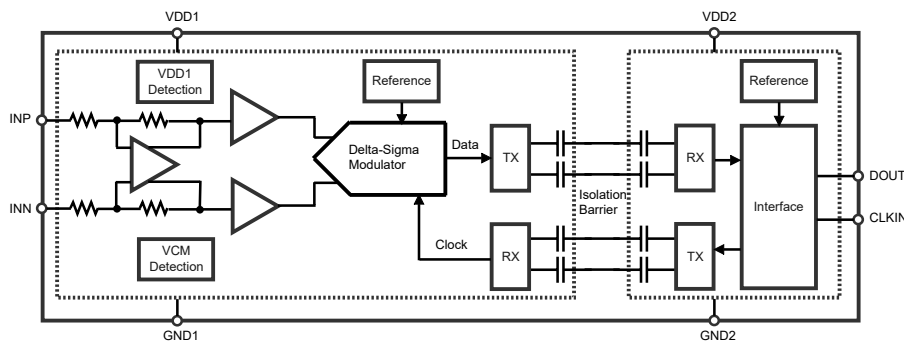


Figure 15. Functional Block Diagram

Feature Description

Fail-Safe Output

The device provides a fail-safe output that simplifies diagnostics on a system level. The fail-safe output is active in two cases:

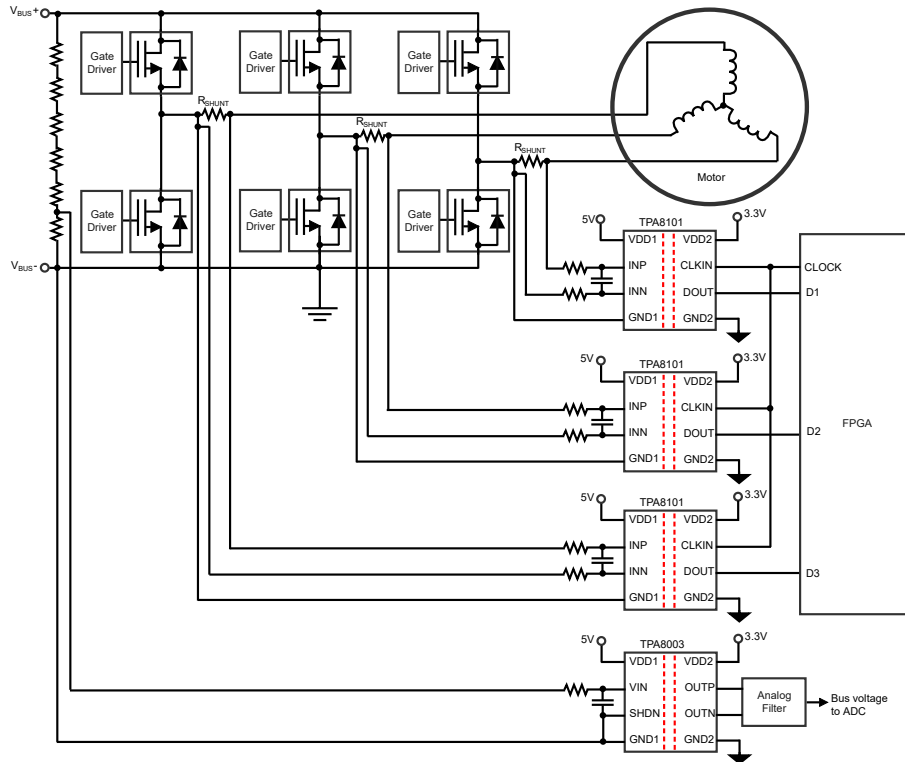
- When the VDD1 is missing, or the voltage at VDD1 is lower than $VDD1_{UV}$ (the undervoltage detection threshold voltage of VDD1), the output DOUT of the device provides a steady-state bitstream of logic 0's.
- When the common-mode input voltage, that is $V_{CM} = (V_{INP} + V_{INN}) / 2$, exceeds the V_{CMov} (the minimum common-mode overvoltage detection level), the output DOUT of the device provides a steady-state bitstream of logic 1's.

Output Behavior in Case of a Full-Scale Input

To distinguish from the output, if a full-scale input signal is applied to the device, the device generates a single one or zero every 128 bits at DOUT, depending on the polarity of the input signal.

Application and Implementation

Typical Application



Motor Drive Application

Isolated amplifiers are widely used in frequency inverters, which are critical parts of industrial motor drives, servo control systems, and other industrial applications.

The TPA8101 products are optimized for current sensing applications with shunt resistors. The figure in typical application section shows a typical operation of the device for current sensing in a motor drive application. Phase current is measured by the shunt resistors, R_{SHUNT} . The differential input and the high common-mode transient immunity of the device ensure reliable and accurate operation in high-noise environments.

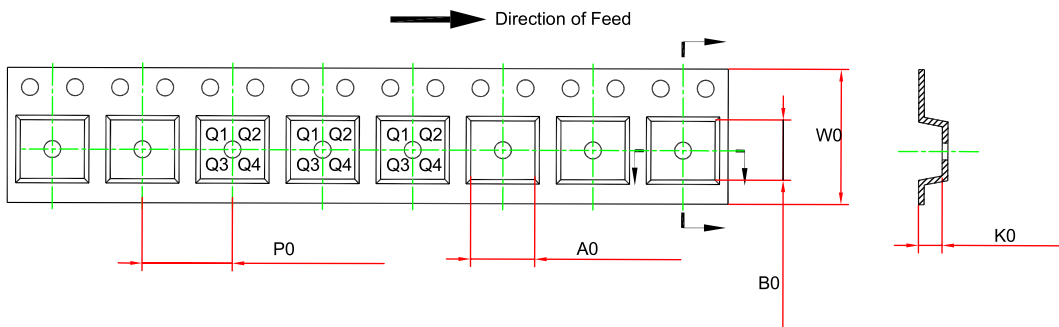
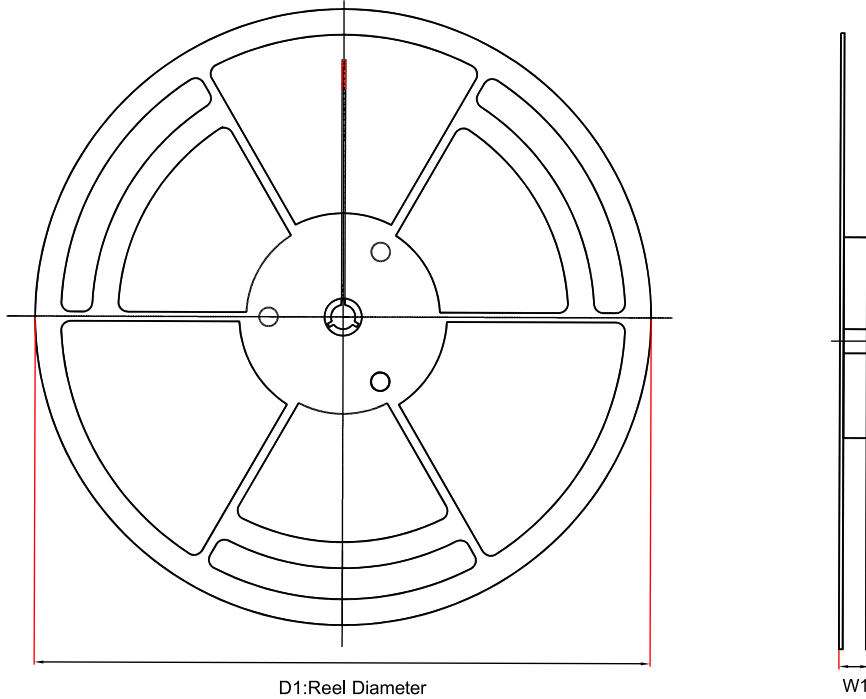
The DC bus voltage is measured by TPA8003 with high-impedance input and wide input voltage range.

Power Supply Recommendation

In a typical frequency inverter application, the high-side power supply (VDD1) of the device is derived by the floating power supply of the upper gate driver. A Zener diode with shunt resistor can be used to provide the high-side power supply of the device, or a low-cost low-dropout regulator (LDO) may be used to reduce the noise on the power supply. Place a 0.1- μF bypass capacitors as close as possible to the VDD1 pin of the device for best performance, an additional 1- μF to 10- μF capacitor may be used for better filtering.

To decouple the low-side power supply, place a 0.1- μF capacitor placed as close to the VDD2 pin of the device as possible, an additional 1- μF to 10- μF capacitor may be used for better filtering.

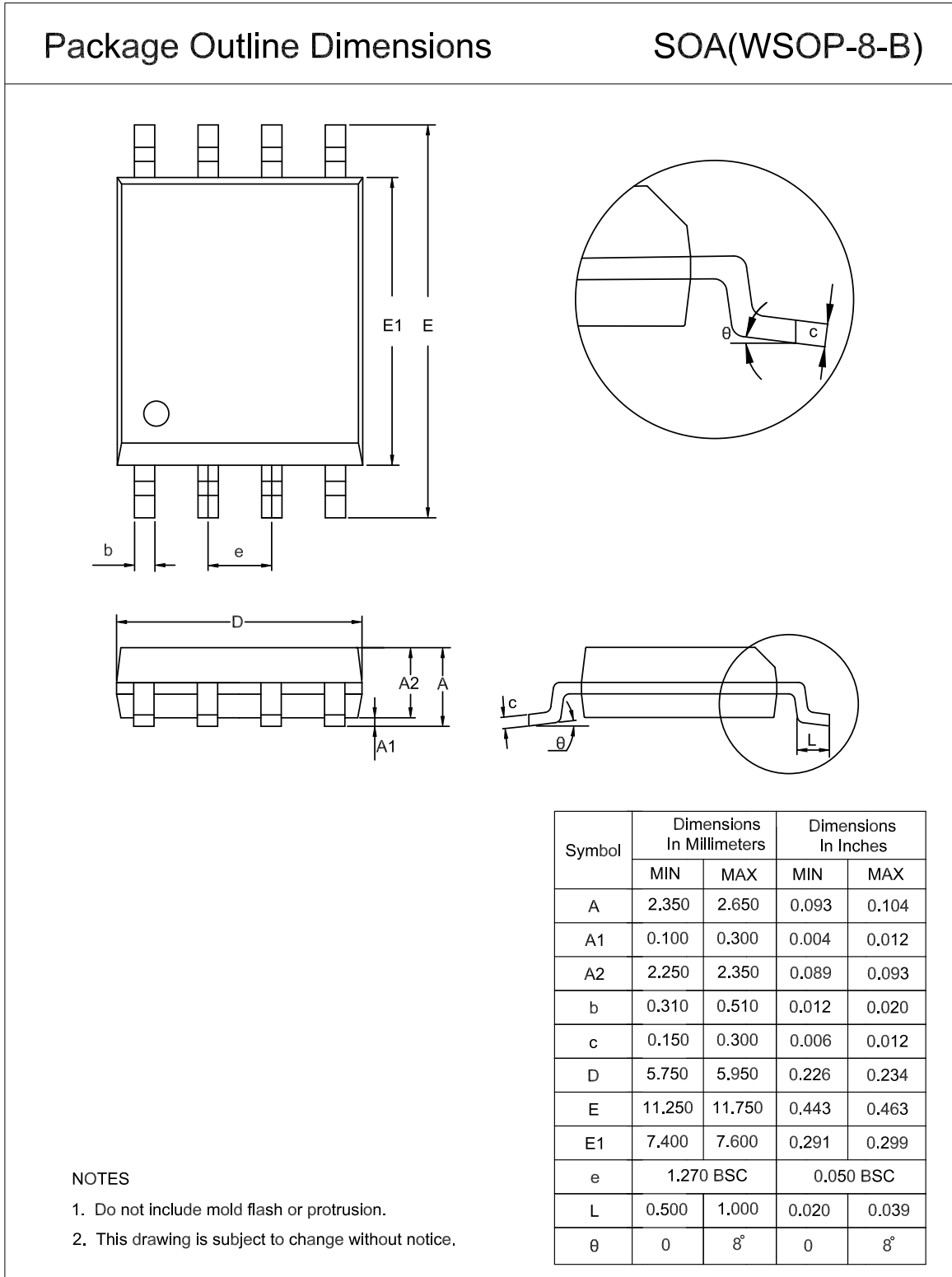
Tape and Reel Information



Order Number	Package	D1 (mm)	W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	W0 (mm)	Pin1 Quadrant
TPA8101-SOAR	WSOP8	330	21.6	11.95	6.2	3.1	16.0	16.0	Q1
TPA8101-TS1R	TSSOP8	330	17.6	6.7	3.4	1.7	8.0	12.0	Q1

Package Outline Dimensions

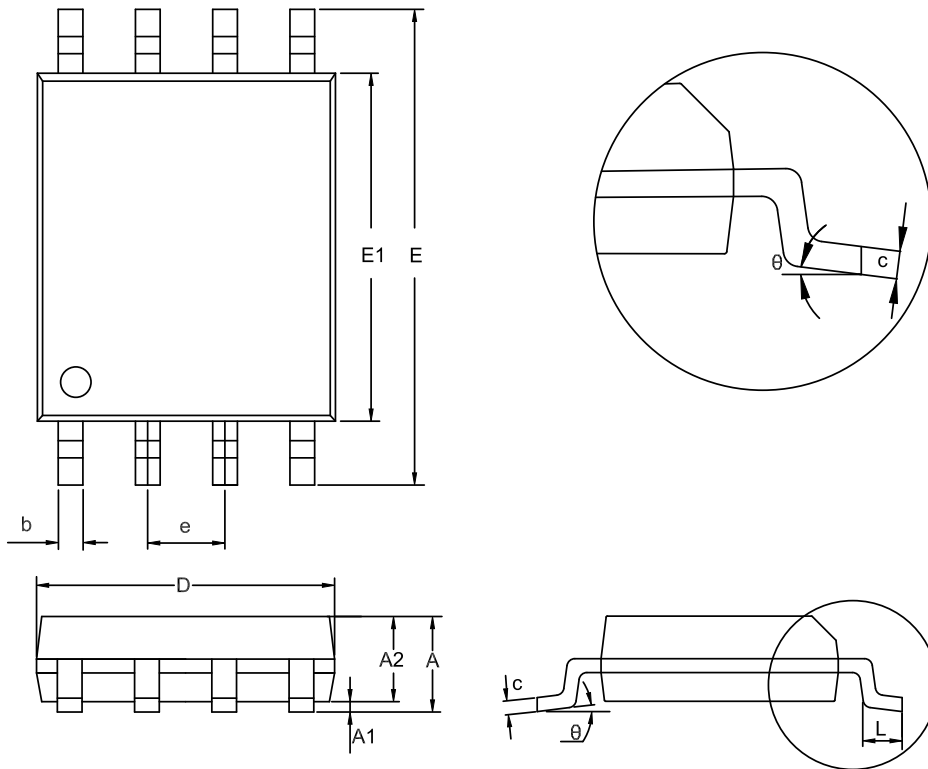
WSOP8-B



TSSOP8

Package Outline Dimensions

TS1(TSSOP-8-A)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	0.900	1.200	0.035	0.047
A1	0.050	0.150	0.002	0.006
A2	0.800	1.050	0.031	0.041
b	0.190	0.300	0.007	0.012
c	0.090	0.200	0.004	0.008
D	2.900	3.100	0.114	0.122
E	6.200	6.600	0.244	0.260
E1	4.300	4.500	0.169	0.177
e	0.650 BSC		0.026 BSC	
L	0.450	0.750	0.018	0.030
θ	0	8°	0	8°

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
TPA8101-SOAR	-40 to 125°C	WSOP8	A8101	MSL3	Tape and Reel, 1000	Green
TPA8101-TS1R ⁽¹⁾	-40 to 125°C	TSSOP8	A8101	MSL3	Tape and Reel, 3000	Green

(1) Future products.

Green: Defines "Green" to mean RoHS compatible and free of halogen substances.

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